

Description

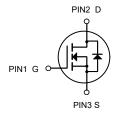
The 20N50 can be used in various power swithching circuit for system miniaturization and higher efficiency. The package form is TO-220/TO-220F, which accords with the RoHS standard.

S G D

TO-220F

General Features

 $V_{DS} = 500V, I_D = 20A$ $R_{DS(ON)} < 0.3 \Omega@V_{GS} = 10V$



N-Channel MOSFET

Application

• Power switch circuit of adaptor and charger.

Package Marking and Ordering Information

Product ID	Pack	Marking	Units Tube
20N50	TO-220F	20N50 XXX YYYY	50

Absolute Maximum Ratings@T =25°C(unless otherwise specified)

Symbol	Parameter	l mit	Unit	
V _{DSS}	Drain-to-Source Voltage ^[1]	500	V	
V _{GSS}	Gate-to-Source Voltage	±30		
I _D	Continuous Drain Current	20		
I _{D @ Tc =100} ℃	Continuous Drain Current @ Tc=100℃	Α		
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2]	Figure 6		
E _{AS}	Single Pulse Avalanche Energy	1500	mJ	
dv/dt	Peak Diode Recovery dv/dt ^[3]	5.0	V/ns	
P _D	Power Dissipation	165	W	
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	$^{\circ}$ C	
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 150		
R _{θJC}	Thermal Resistance, Junction-to-Case	2.27	°C AA/	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	°C/W	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



Electrical Characteristics T_J =25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	
BV _{DSS}	Drain-to-Source Breakdown Voltage	500			V	V _{GS} =0V, I _D =250uA	
				1		V _{DS} =500V, V _{GS} =0V	
I _{DSS}	Drain-to-Source Leakage Current			100	uA	V_{DS} =400V, V_{GS} =0V, T_J =125°C	
I _{GSS}	Cata ta Cauraa Laakaria Currant			+100	nA	V _{GS} =+30V, V _{DS} =0V	
	Gate-to-Source Leakage Current			-100		V _{GS} =-30V, V _{DS} =0V	
R _{DS(ON)}	Static Drain-to-Source On-Resistance ^[4]		0.26	0.3	Ω	V _{GS} =10V, I _D =10A	
V _{GS(TH)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250uA$	
gfs	Forward Transconductance ^[4]		17		S	VDS=15V,ID=10A	
C _{iss}	Input Capacitance		2864		pF	V_{GS} =0V, V_{DS} =25V, f =1.0MH $_{Z}$	
C _{rss}	Reverse Transfer Capacitance		25				
C _{oss}	Output Capacitance		286				
Qg	Total Gate Charge		63			V_{DD} =250V, I_{D} =20A, V_{GS} =0 to 10V	
Q _{gs}	Gate-to-Source Charge		14		nC		
Q _{gd}	Gate-to-Drain (Miller) Charge		24			<i>J</i> = 11.9, 100 0 10 10 1	
td(ON)	Turn-on Delay Time		33			V_{DD} =250V, I_{D} =20A, V_{GS} = 10V R_{G} =25 Ω	
trise	Rise Time		75				
td(OFF)	Turn-Off Delay Time		181		nS		
t fall	Fall Time		83				
I _{SD}	Continuous Source Current ^[4]			20	۸	Integral PN-diode in	
I _{SM}	Pulsed Source Current ^[4]			80	Α	MOSFET	
V _{SD}	Diode Forward Voltage			1.5	V	I _S =20A, V _{GS} =0V	
trr	Reverse recovery time		392		V	V _{GS} =0V ,I _F =20A,	
Qrr	Reverse recovery charge		3.3		uC	dir/dt=100A/µs	

Note:

^[3] ISD= 20A di/dt < 100 A/μs, VDD < BVDSS, TJ=+150℃. [4] Pulse width≤380μs; duty cycle≤2%.

Typical Characteristics

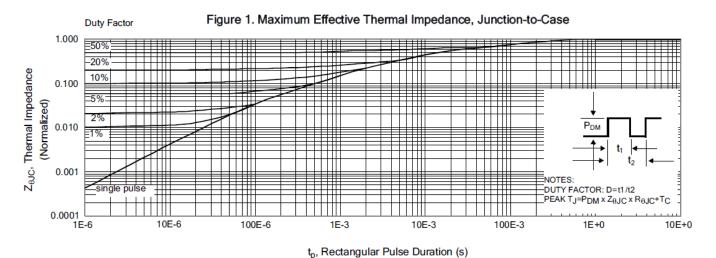


Figure 2. Maximum Power Dissipation vs Case Temperature

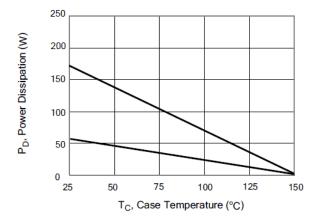


Figure 4. Typical Output Characteristics

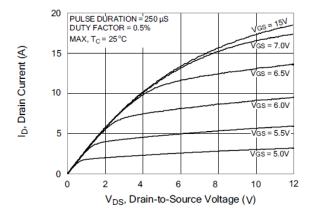


Figure 3. Maximum Continuous Drain Current vs Case Temperature

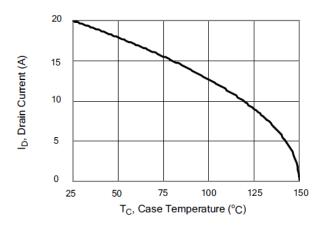


Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current

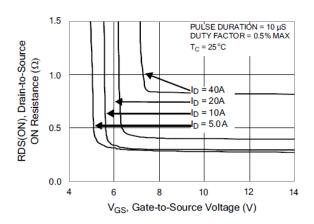




Figure 6. Maximum Peak Current Capability

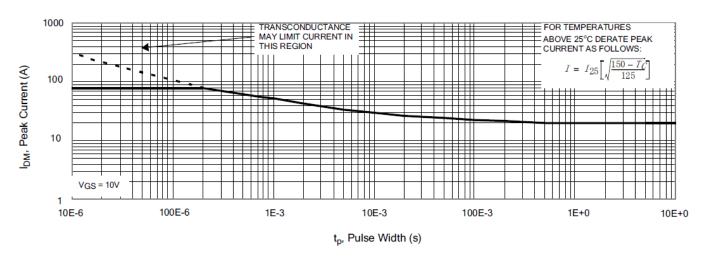


Figure 7. Typical Transfer Characteristics

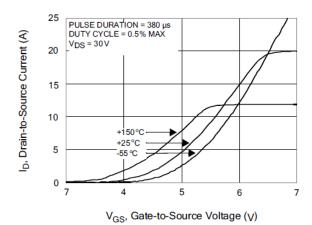
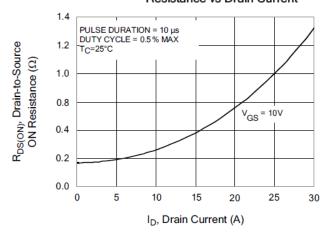


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current



Unclamped Inductive Figure 8. Switching Capability

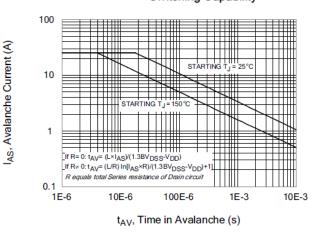
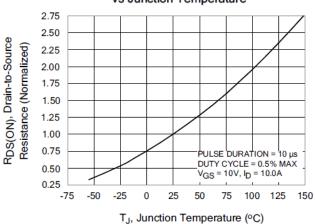
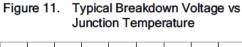


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature





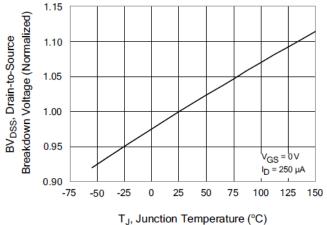


Figure 13. Maximum Forward Bias Safe Operating Area

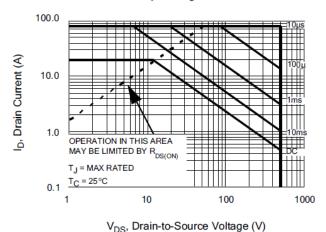


Figure 15. Typical Gate Charge

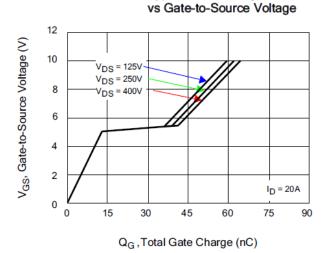


Figure 12. Typical Threshold Voltage vs Junction Temperature

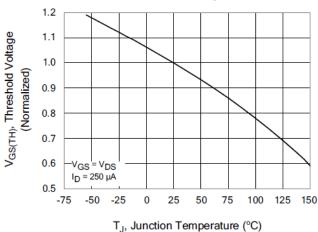


Figure 14. Typical Capacitance vs Drain-to-Source Voltage

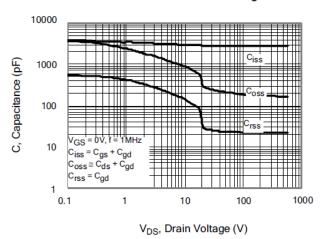
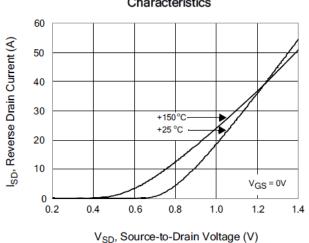
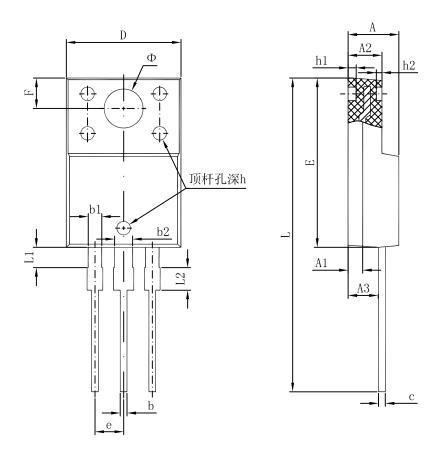


Figure 16. Typical Body Diode Transfer Characteristics



Package Dimension TO-220F



Cymbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.300	4.700	0.169	0.185	
A1	1.300 REF.		0.051 REF.		
A2	2.800	3.200	0.110	0.126	
A3	2.500	2.900	0.098	0.114	
b	0.500	0.750	0.020	0.030	
b1	1.100	1.350	0.043	0.053	
b2	1.500	1.750	0.059	0.069	
С	0.500	0.750	0.020	0.030	
D	9.960	10.360	0.392	0.408	
E	14.800	15.200	0.583	0.598	
е	2.540 TYP.		0.100 TYP.		
F	2.700 REF.		0.106 REF.		
Φ	3.500 REF.		0.138 REF.		
h	0.000	0.300	0.000	0.012	
h1	0.800 REF.		0.031 REF.		
h2	0.500 REF.		0.020 REF.		
L	28.000	28.400	1.102	1.118	
L1	1.700	1.900	0.067	0.075	
L2	1.900	2.100	0.075	0.083	



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